

Electronic Patent Application Fee Transmittal

Application Number:	10663304			
Filing Date:	16-Sep-2003			
Title of Invention:	Method of fabricating a dual damascene interconnect structure			
First Named Inventor/Applicant Name:	Kallol Bera			
Filer:	Alan Michael Taboada			
Attorney Docket Number:	8477/ETCH/DRIE			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Filing a brief in support of an appeal	1402	1	500	500
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				500